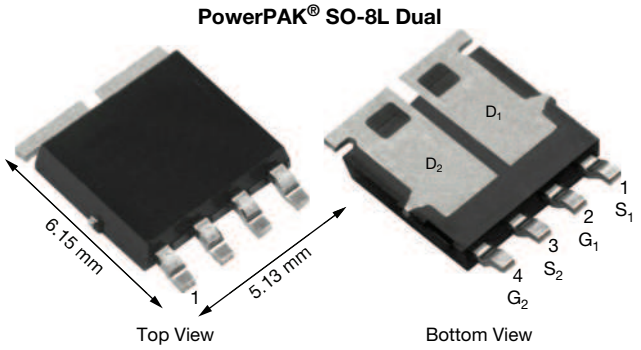
Automotive N- and P-Channel 40 V (D-S) 175 °C MOSFET

PowerPAK® SO-8L Dual



FEATURES

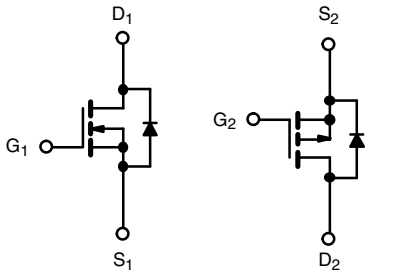
- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE GRADE

Pb-free

RoHS COMPLIANT

HALOGEN FREE



PRODUCT SUMMARY		
	N-CHANNEL	P-CHANNEL
V_{DS} (V)	40	-40
$R_{DS(on)}$ (Ω) at V_{GS} = ± 10 V	0.0075	0.0170
$R_{DS(on)}$ (Ω) at V_{GS} = ± 4.5 V	0.0110	0.0230
I_D (A)	30	-30
Configuration	N- and p-pair	
Package		

ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and halogen-free	SQJ504EP (for detailed order number please see www.vishay.com/doc?79771)

ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted)

PARAMETER		SYMBOL	N-CHANNEL	P-CHANNEL	UNIT
Drain-source voltage		V_{DS}	40	-40	V
Gate-source voltage		V_{GS}	± 20		
Continuous drain current	T_C = 25 °C	I_D	30 [a]	-30 [a]	A
	T_C = 125 °C		29.3	-19.5	
Continuous source current (diode conduction) [a]		I_S	30	-30	
Pulsed drain current [b]		I_{DM}	90	-84	
Single pulse avalanche current	L = 0.1 mH	I_{AS}	25	-24	
Single pulse avalanche Energy		E_{AS}	31.2	28.8	mJ
Maximum power dissipation [b]	T_C = 25 °C	P_D	34	34	W
	T_C = 125 °C		11	11	
Operating junction and storage temperature range		T_J, T_{stg}	-55 to +175		°C
Soldering recommendations (peak temperature) [d, e]			260		

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	N-CHANNEL	P-CHANNEL	UNIT
Junction-to-ambient	PCB mount [c]	R_{thJA}	85	85	°C/W
Junction-to-case (drain)		R_{thJC}	4.3	4.3	

Notes

a. Package limited
b. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %
c. When mounted on 1" square PCB (FR4 material)
d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

For technical questions, contact: automostechsupport@vishay.com

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

SPECIFICATIONS (T_C = 25 °C, unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS			MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V_{DS}	V_{GS} = 0 V, I_D = 250 µA		N-Ch	40	-	-	V
		V_{GS} = 0 V, I_D = -250 µA		P-Ch	-40	-	-	
Gate-source threshold voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 µA		N-Ch	1.5	2	2.5	
		V_{DS} = V_{GS}, I_D = -250 µA		P-Ch	-1.5	-2	-2.5	
Gate-source leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V		N-Ch	-	-	± 100	nA
				P-Ch	-	-	± 100	
Zero gate voltage drain current	I_{DSS}	V_{GS} = 0 V	V_{DS} = 40 V	N-Ch	-	-	1	µA
		V_{GS} = 0 V	V_{DS} = -40 V	P-Ch	-	-	-1	
		V_{GS} = 0 V	V_{DS} = 40 V, T_J = 125 °C	N-Ch	-	-	50	
		V_{GS} = 0 V	V_{DS} = -40 V, T_J = 125 °C	P-Ch	-	-	-50	
		V_{GS} = 0 V	V_{DS} = 40 V, T_J = 175 °C	N-Ch	-	-	150	
		V_{GS} = 0 V	V_{DS} = -40 V, T_J = 175 °C	P-Ch	-	-	-150	
On-state drain current [a]	$I_{D(on)}$	V_{GS} = 10 V	V_{DS} ≥ 5 V	N-Ch	10	-	-	A
		V_{GS} = -10 V	V_{DS} ≤ 5 V	P-Ch	-10	-	-	
Drain-source on-state resistance [a]	$R_{DS(on)}$	V_{GS} = 10 V	I_D = 8 A	N-Ch	-	0.0061	0.0075	Ω
		V_{GS} = -10 V	I_D = -8 A	P-Ch	-	0.0138	0.0170	
		V_{GS} = 10 V	I_D = 8 A, T_J = 125 °C	N-Ch	-	-	0.0110	
		V_{GS} = -10 V	I_D = -8 A, T_J = 125 °C	P-Ch	-	-	0.0254	
		V_{GS} = 10 V	I_D = 8 A, T_J = 175 °C	N-Ch	-	-	0.0130	
		V_{GS} = -10 V	I_D = -8 A, T_J = 175 °C	P-Ch	-	-	0.0304	
		V_{GS} = 4.5 V	I_D = 5 A	N-Ch	-	0.0088	0.0110	
		V_{GS} = -4.5 V	I_D = -5 A	P-Ch	-	0.0186	0.0230	
Forward transconductance [b]	g_{fs}	V_{DS} = 15 V, I_D = 8 A		N-Ch	-	35	-	S
		V_{DS} = -15 V, I_D = -8 A		P-Ch	-	30	-	
Dynamic [b]								
Input capacitance	C_{iss}	V_{GS} = 0 V	V_{DS} = 25 V, f = 1 MHz	N-Ch	-	1355	1900	pF
		V_{GS} = 0 V	V_{DS} = -25 V, f = 1 MHz	P-Ch	-	3340	4600	
Output capacitance	C_{oss}	V_{GS} = 0 V	V_{DS} = 25 V, f = 1 MHz	N-Ch	-	875	1400	
		V_{GS} = 0 V	V_{DS} = -25 V, f = 1 MHz	P-Ch	-	230	320	
Reverse transfer capacitance	C_{rss}	V_{GS} = 0 V	V_{DS} = 25 V, f = 1 MHz	N-Ch	-	35	50	
		V_{GS} = 0 V	V_{DS} = -25 V, f = 1 MHz	P-Ch	-	216	300	
Total gate charge [c]	Q_g	V_{GS} = 10 V	V_{DS} = 20 V, I_D = 5 A	N-Ch	-	18	30	nC
		V_{GS} = -10 V	V_{DS} = -20 V, I_D = -5 A	P-Ch	-	56	85	
Gate-source charge [c]	Q_{gs}	V_{GS} = 10 V	V_{DS} = 20 V, I_D = 5 A	N-Ch	-	3.5	-	
		V_{GS} = -10 V	V_{DS} = -20 V, I_D = -5 A	P-Ch	-	8.5	-	
Gate-drain charge [c]	Q_{gd}	V_{GS} = 10 V	V_{DS} = 20 V, I_D = 5 A	N-Ch	-	2.6	-	
		V_{GS} = -10 V	V_{DS} = -20 V, I_D = -5 A	P-Ch	-	9.9	-	
Gate resistance	R_g	f = 1 MHz		N-Ch	0.3	0.72	1.2	Ω
				P-Ch	1.15	2.37	3.6	

For technical questions, contact: automostechsupport@vishay.com
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

SPECIFICATIONS (T_C = 25 °C, unless otherwise noted)							
PARAMETER	**SYMBOL**	**TEST CONDITIONS**		**MIN.**	**TYP.**	**MAX.**	**UNIT**
Turn-on delay time [c]	$t_{d(on)}$	V_{DD} = 20 V, R_L = 4 Ω, $I_D \cong$ 5 A, V_{GEN} = 10 V, R_g = 1 Ω	N-Ch	-	11	20	ns
		V_{DD} = -20 V, R_L = 4 Ω, $I_D \cong$ -5 A, V_{GEN} = -10 V, R_g = 1 Ω	P-Ch	-	15	25	
Rise time [c]	t_r	V_{DD} = 20 V, R_L = 4 Ω, $I_D \cong$ 5 A, V_{GEN} = 10 V, R_g = 1 Ω	N-Ch	-	4	10	
		V_{DD} = -20 V, R_L = 4 Ω, $I_D \cong$ -5 A, V_{GEN} = -10 V, R_g = 1 Ω	P-Ch	-	6	10	
Turn-off delay time [c]	$t_{d(off)}$	V_{DD} = 20 V, R_L = 4 Ω, $I_D \cong$ 5 A, V_{GEN} = 10 V, R_g = 1 Ω	N-Ch	-	21	35	
		V_{DD} = -20 V, R_L = 4 Ω, $I_D \cong$ -5 A, V_{GEN} = -10 V, R_g = 1 Ω	P-Ch	-	45	70	
Fall time [c]	t_f	V_{DD} = 20 V, R_L = 4 Ω, $I_D \cong$ 5 A, V_{GEN} = 10 V, R_g = 1 Ω	N-Ch	-	5	10	
		V_{DD} = -20 V, R_L = 4 Ω, $I_D \cong$ -5 A, V_{GEN} = -10 V, R_g = 1 Ω	P-Ch	-	7	12	
Source-Drain Diode Ratings and Characteristics [b]							
Pulsed current [a]	I_{SM}		N-Ch	-	-	90	A
			P-Ch	-	-	-84	
Forward voltage	V_{SD}	I_S = 8 A, V_{GS} = 0 V	N-Ch	-	0.803	1.2	V
		I_S = -8 A, V_{GS} = 0 V	P-Ch	-	-0.790	-1.2	
Body diode reverse recovery time	t_{rr}	I_F = 5 A, di/dt = 100 A/µs	N-Ch	-	48	100	ns
		I_F = -5 A, di/dt = 100 A/µs	P-Ch	-	26	55	
Body diode reverse recovery charge	Q_{rr}	I_F = 5 A, di/dt = 100 A/µs	N-Ch	-	54	110	nC
		I_F = -5 A, di/dt = 100 A/µs	P-Ch	-	22	45	
Reverse recovery fall time	t_a	I_F = 5 A, di/dt = 100 A/µs	N-Ch	-	25	-	ns
		I_F = -5 A, di/dt = 100 A/µs	P-Ch	-	15	-	
Reverse recovery rise time	t_b	I_F = 5 A, di/dt = 100 A/µs	N-Ch	-	23	-	
		I_F = -5 A, di/dt = 100 A/µs	P-Ch	-	11	-	
Body diode peak reverse recovery current	$I_{RM(REC)}$	I_F = 5 A, di/dt = 100 A/µs	N-Ch	-	-2.1	-	A
		I_F = -5 A, di/dt = 100 A/µs	P-Ch	-	-1.7	-	

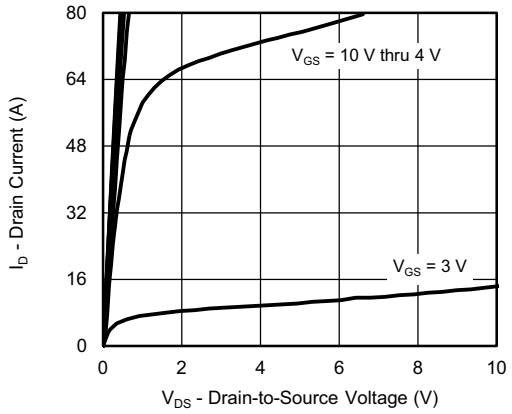
Notes

a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %
b. Guaranteed by design, not subject to production testing
c. Independent of operating temperature

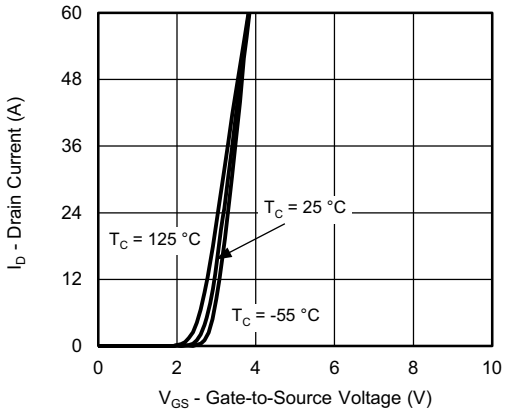
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

For technical questions, contact: automostechsupport@vishay.com
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

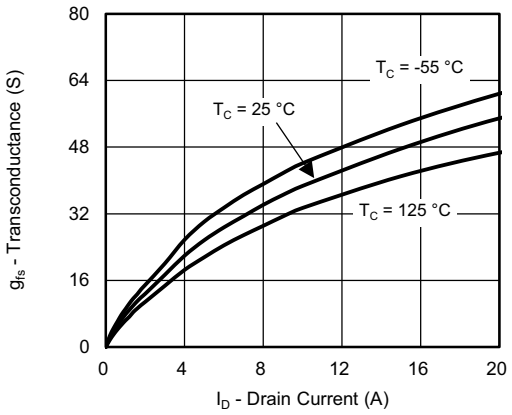
N-CHANNEL TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



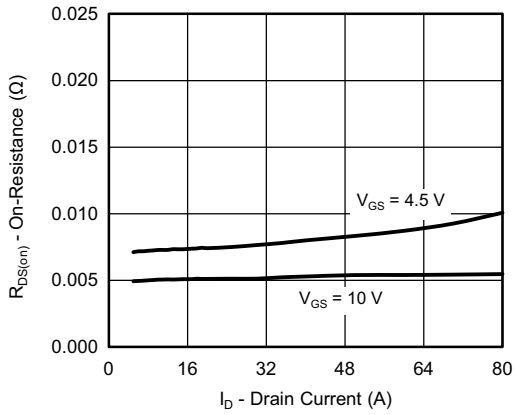
Output Characteristics



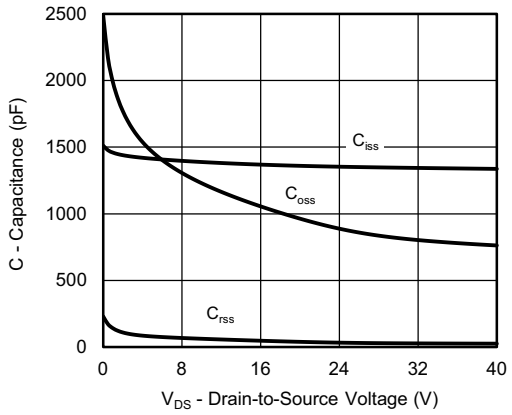
Transfer Characteristics



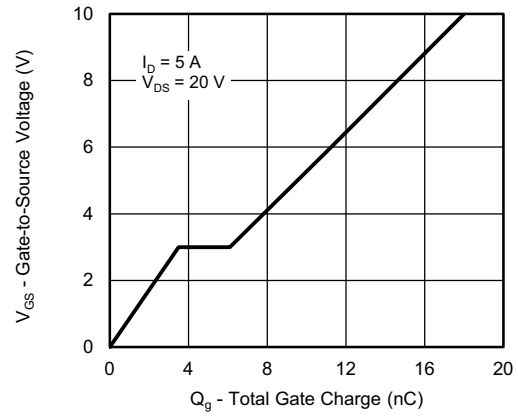
Transconductance



On-Resistance vs. Drain Current



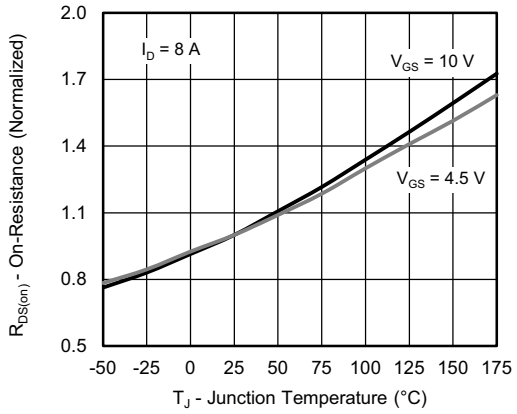
Capacitance



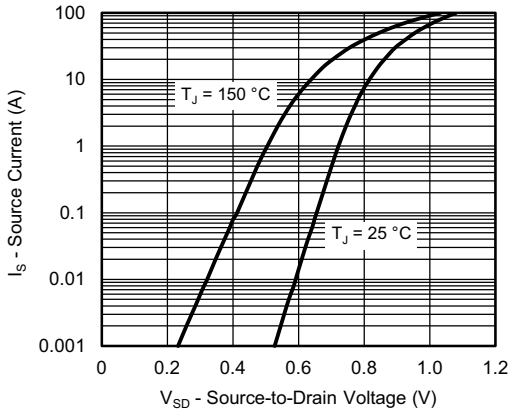
Gate Charge

For technical questions, contact: automostechsupport@vishay.com
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

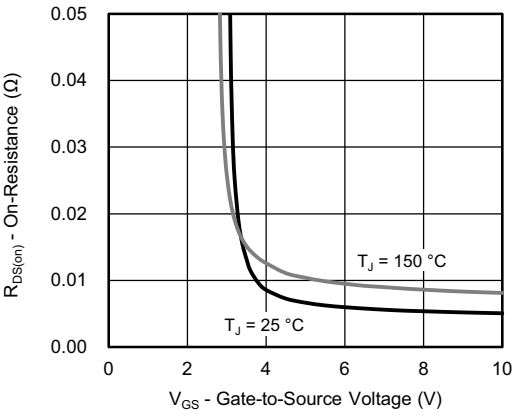
N-CHANNEL TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



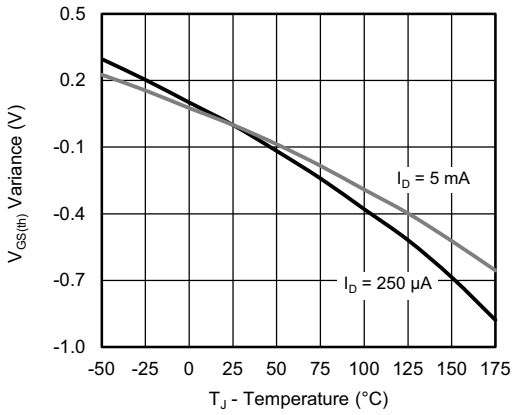
On-Resistance vs. Junction Temperature



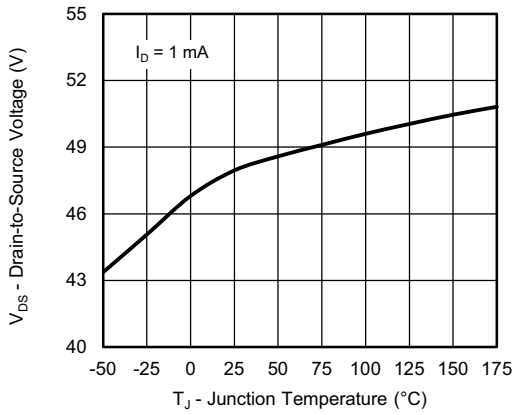
Source Drain Diode Forward Voltage



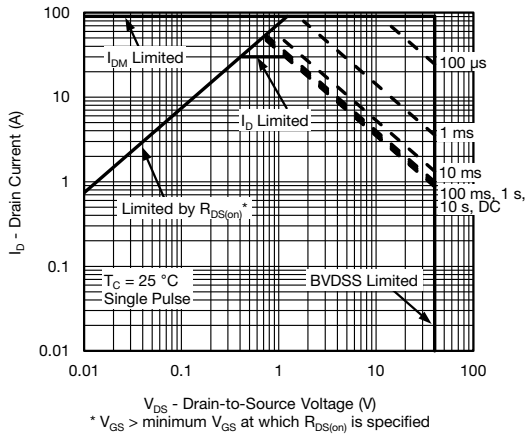
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



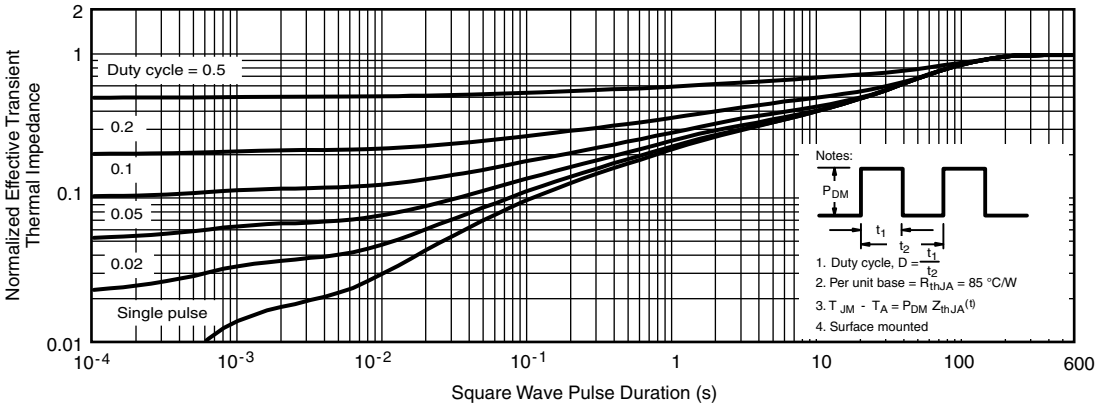
Drain Source Breakdown vs. Junction Temperature



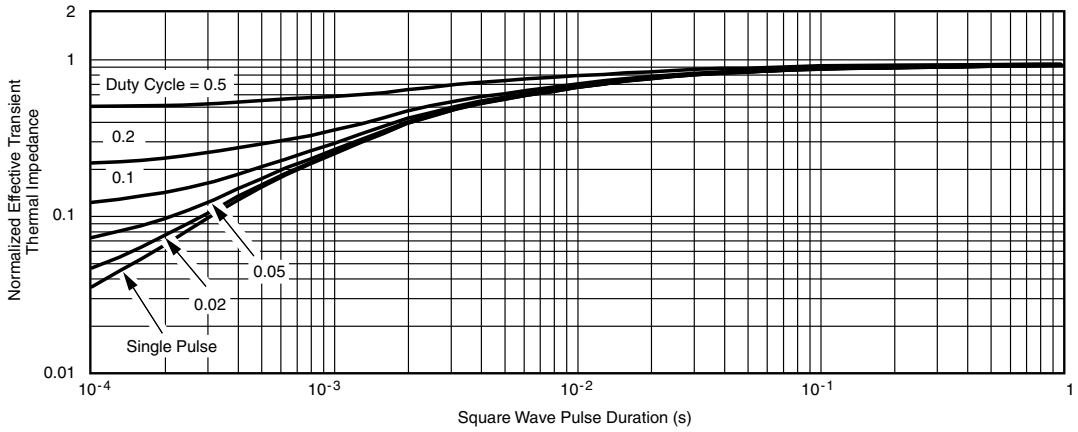
Safe Operating Area

For technical questions, contact: automostechsupport@vishay.com
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

N-CHANNEL TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

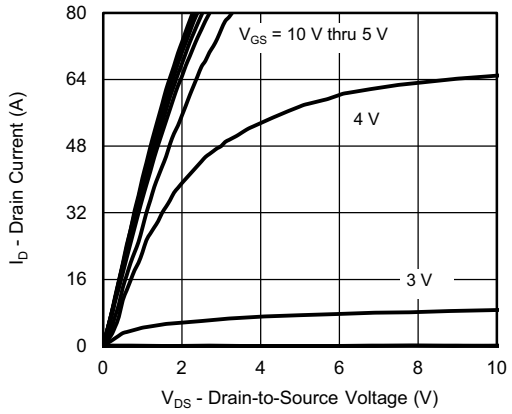
- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

  are given for general guidelines only to enable the user to get a “ball park” indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

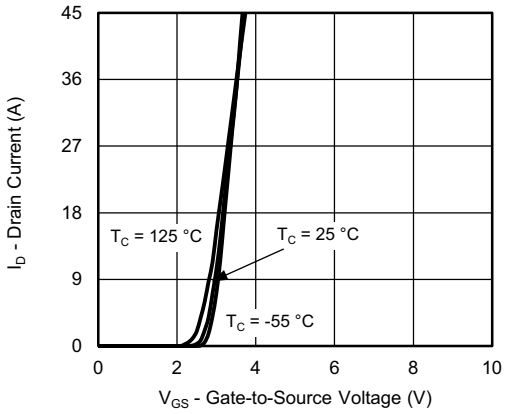
For technical questions, contact: automostechsupport@vishay.com

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

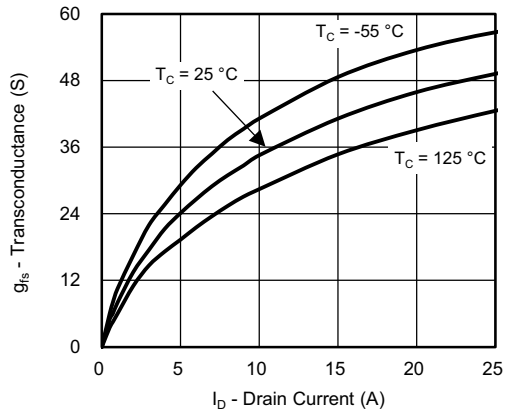
P-CHANNEL TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



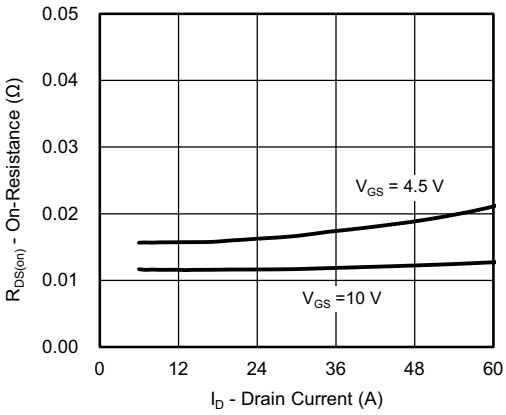
Output Characteristics



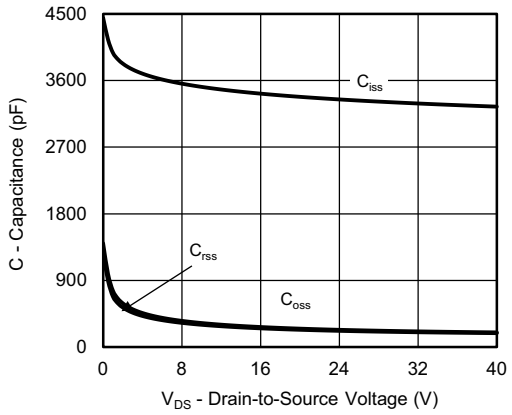
Transfer Characteristics



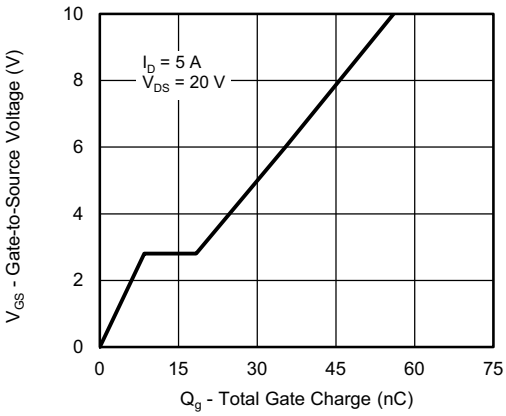
Transconductance



On-Resistance vs. Drain Current



Capacitance

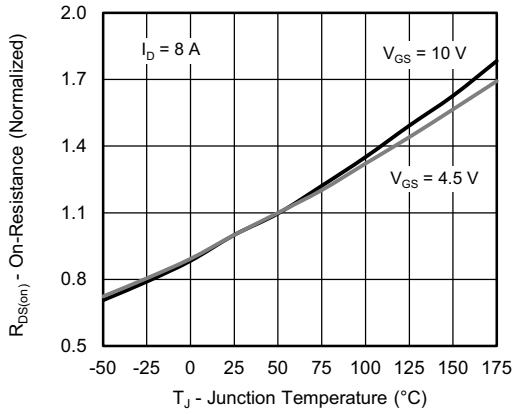


Gate Charge

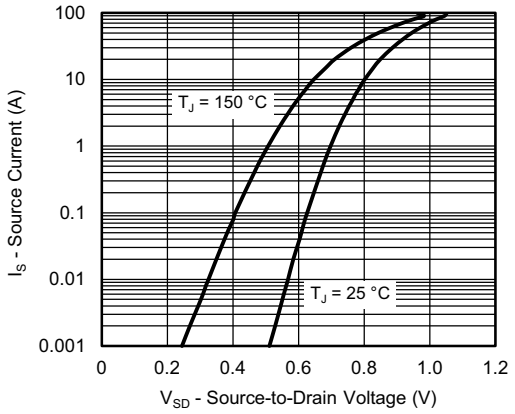
For technical questions, contact: automostechsupport@vishay.com

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

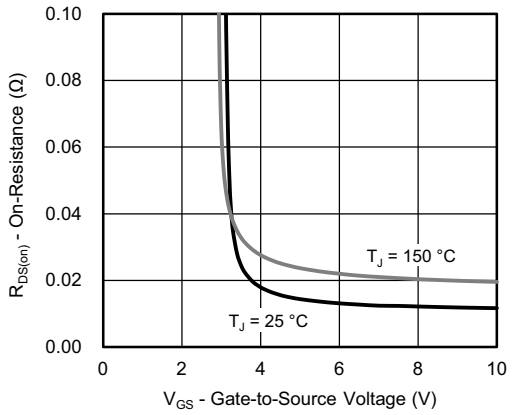
P-CHANNEL TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



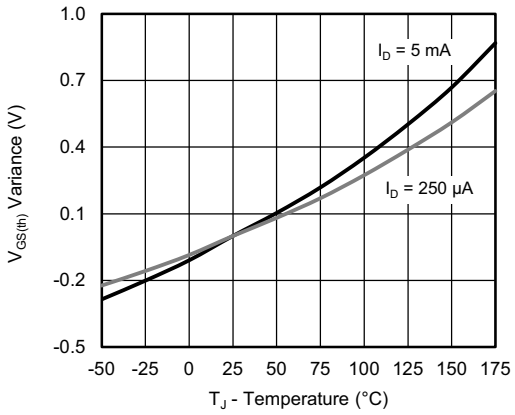
Threshold Voltage



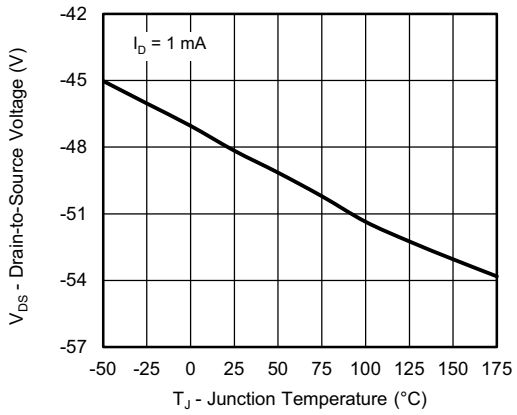
Source Drain Diode Forward Voltage



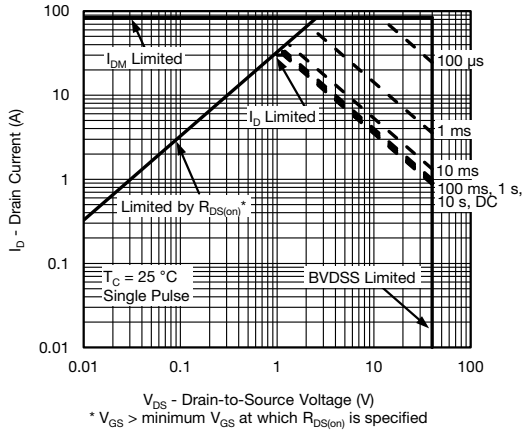
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



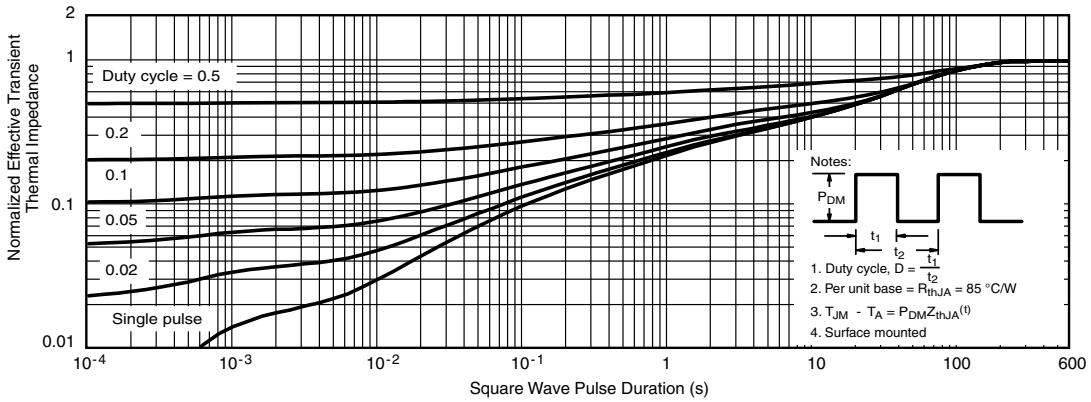
Drain Source Breakdown vs. Junction Temperature



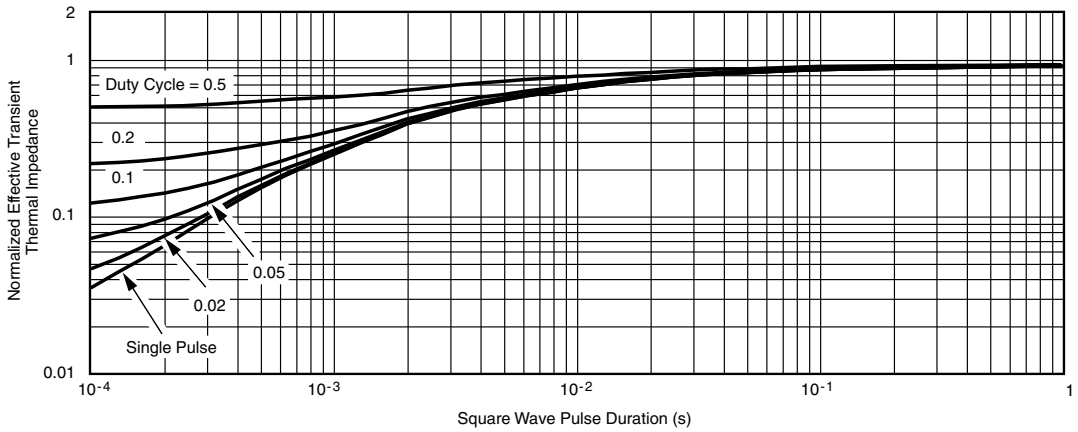
Safe Operating Area

For technical questions, contact: automostechsupport@vishay.com
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

P-CHANNEL TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

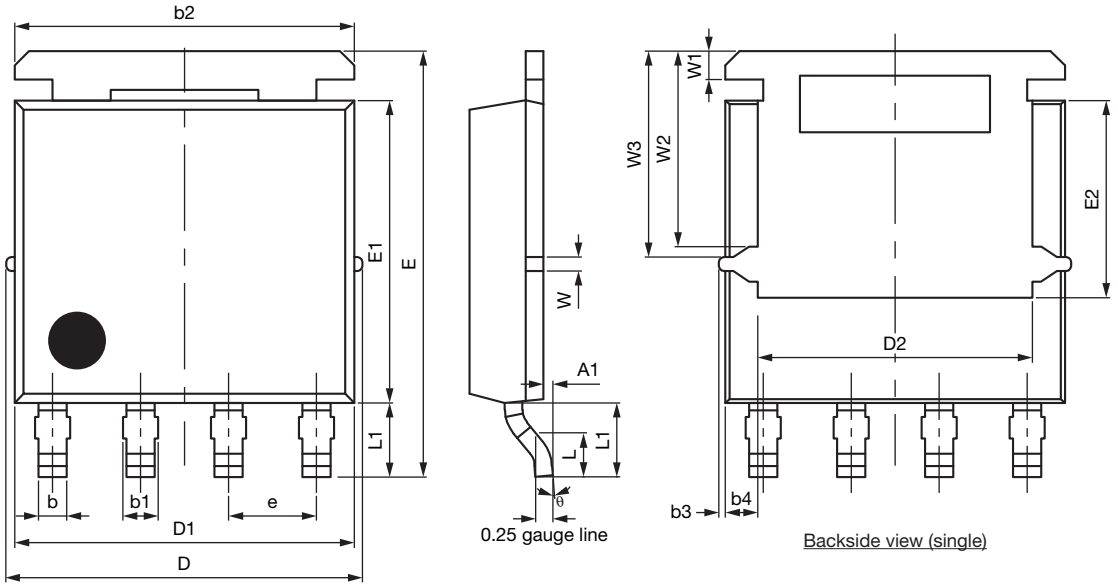
  are given for general guidelines only to enable the user to get a “ball park” indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?76029.

For technical questions, contact: automostechsupport@vishay.com

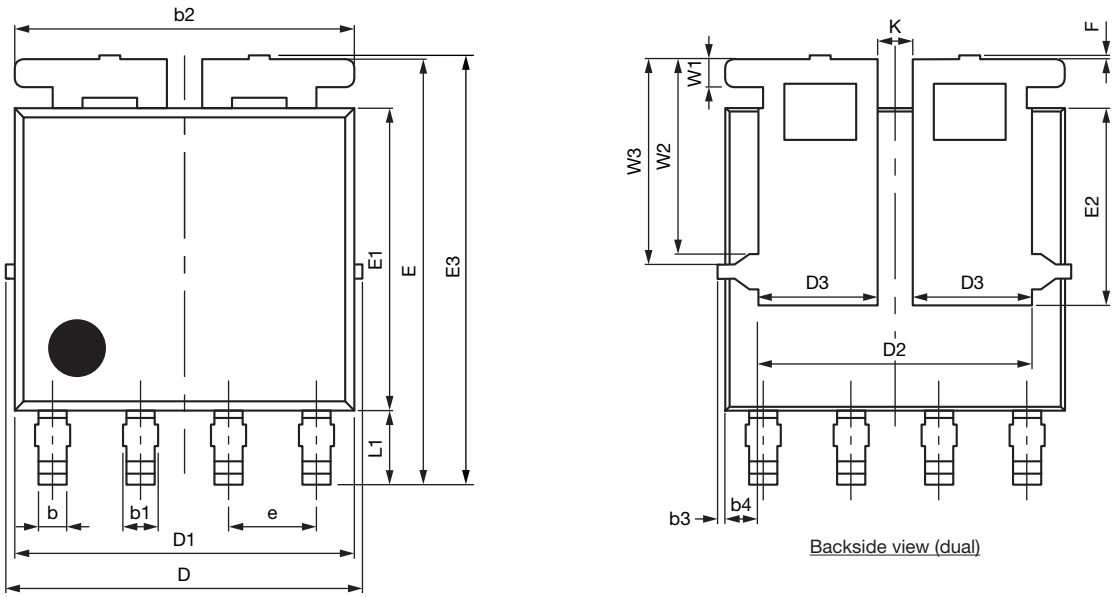
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

PowerPAK® SO-8L Case Outline 2



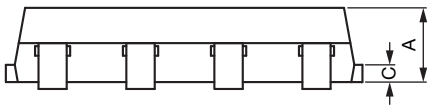
Topside view (single)

Backside view (single)



Topside view (dual)

Backside view (dual)



For technical questions, contact: pmostechsupport@vishay.com

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

DIM.	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	1.00	1.07	1.14	0.039	0.042	0.045
A1	0.00	-	0.127	0.00	-	0.005
b	0.33	0.41	0.48	0.013	0.016	0.019
b1	0.44	0.51	0.58	0.017	0.020	0.023
b2	4.80	4.90	5.00	0.189	0.193	0.197
b3	0.094			0.004		
b4	0.47			0.019		
c	0.20	0.25	0.30	0.008	0.010	0.012
D	5.00	5.13	5.25	0.197	0.202	0.207
D1	4.80	4.90	5.00	0.189	0.193	0.197
D2	3.86	3.96	4.06	0.152	0.156	0.160
D3	1.63	1.73	1.83	0.064	0.068	0.072
e	1.27 BSC			0.050 BSC		
E	6.05	6.15	6.25	0.238	0.242	0.246
E1	4.27	4.37	4.47	0.168	0.172	0.176
E2	2.75	2.85	2.95	0.108	0.112	0.116
E3	6.05	6.22	6.40	0.238	0.245	0.252
F	-	-	0.15	-	-	0.006
L	0.62	0.72	0.82	0.024	0.028	0.032
L1	0.92	1.07	1.22	0.036	0.042	0.048
K	0.51			0.020		
W	0.23			0.009		
W1	0.41			0.016		
W2	2.82			0.111		
W3	2.96			0.117		
θ	0°	-	10°	0°	-	10°
ECN: C23-1026-Rev. D, 25-Sep-2023 DWG: 6044						

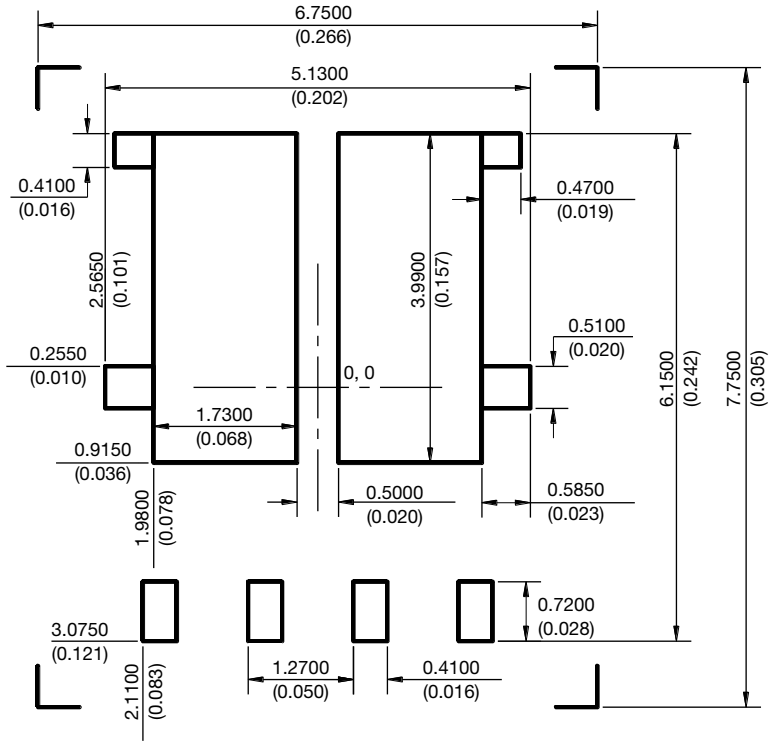
Note

- Millimeters will govern

For technical questions, contact: pmostechsupport@vishay.com

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

RECOMMENDED MINIMUM PAD FOR PowerPAK® SO-8L DUAL



Recommended Minimum Pads
Dimensions in mm (inches)
Keep-out 6.75 (0.266) x 7.75 (0.305)

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, “Vishay”), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

© 2026 VISHAY INTERTECHNOLOGY, INC. ALL RIGHTS RESERVED

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000